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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/976,167	10/12/2001	Frederick Paul Benning	ROC920010111US1	1982	
7590 06/22/2005			EXAM	EXAMINER	
James R. Nocl	k:		AHMED,	AHMED, SHAMIM	
IBM Corporation 3605 Highway 52 North			ART UNIT	PAPER NUMBER	
Rochester, MN 55901-7829			1765		
			DATE MAILED: 06/22/2006	DATE MAILED: 06/22/2005	

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)		
Office Asticus Communication	09/976,167	BENNING ET AL.		
Office Action Summary	Examiner	Art Unit		
The MAIL INC DATE of this communication and	Shamim Ahmed	1765	_	
The MAILING DATE of this communication app Period for Reply	oears on the cover sheet with the t	correspondence address		
A SHORTENED STATUTORY PERIOD FOR REPL' THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a repl - If NO period for reply is specified above, the maximum statutory period of Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be ting within the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from the cause the application to become ABANDONE.	nely filed /s will be considered timely. I the mailing date of this communication. ED (35 U.S.C. § 133).		
Status				
1)⊠ Responsive to communication(s) filed on 11 A	pril 200 <u>5</u> .			
2a)⊠ This action is FINAL . 2b)□ This				
3) Since this application is in condition for allowa	or allowance except for formal matters, prosecution as to the merits is			
closed in accordance with the practice under E	Ex parte Quayle, 1935 C.D. 11, 4	53 O.G. 213.		
Disposition of Claims				
4) ⊠ Claim(s) 1,3-18,35 and 40-42 is/are pending in 4a) Of the above claim(s) is/are withdra 5) □ Claim(s) is/are allowed. 6) ⊠ Claim(s) 1,3-18,35 and 40-42 is/are rejected. 7) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restriction and/or	wn from consideration.			
Application Papers	•	• 4		
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) accomposite and applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Examine 11.	cepted or b) objected to by the drawing(s) be held in abeyance. Se tion is required if the drawing(s) is ob	e 37 CFR 1.85(a). ojected to. See 37 CFR 1.121(d).		
Priority under 35 U.S.C. § 119				
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority application from the International Burea * See the attached detailed Office action for a list	ts have been received. ts have been received in Applicat crity documents have been receiv u (PCT Rule 17.2(a)).	ion No ed in this National Stage		
Attachment(s)	·			
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal (6) Other:			

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DETAILED ACTION

Response to Arguments

1. Applicant's arguments filed 4/11/05 have been fully considered but they are not persuasive. Applicants argue that Ma et al do not disclose a composition used for superfinishing a surface of disk substrate, wherein the disk substrate for use in a data storage device.

In response, examiner states that the argument is not persuasive because a composition is what it is but not what it does. It is also noted that the composition is capable of superfinishing the disk substrate, which is an intended use of the composition because it includes all the constituents as the instant invention.

Applicants also argue that Hartog et al in view of Kramer et al do not teach the claimed invention because Kramer et al reference are not in the context of superfinishing a surface of a disk substrate for use in a data storage device.

In response, examiner states that the argument is not persuasive because the intended use of a composition is not given patentable weight, as the composition is capable of doing so. See MPEP 2114.

Claim Rejections - 35 USC § 103

2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

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- 3. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).
- 4. Claims 1,4-10,13-18 and 35 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ma et al (US 2003/0079416 A1).

Ma et al disclose a polishing composition comprising carrying fluid such as acids, colloidal particles, ferric nitrate, which resemble as the metal etchant and a surfactant of cationic or anionic (paragraphs 0047-0051, paragraphs 0053 and 0059-0061).

Ma et al disclose that the surfactants causes steric repulsion among the particles (paragraph 0060) but do not explicitly teach that the surfactants causes steric hindrance barrier between the substrate and the particles.

However, Ma et al teach that the abrasive particles may comprise silica, alumina, ceria and mixture thereof (paragraph 0068) and hence the surfactants causes steric repulsion among the particles (paragraph 0060).

Ma et al also teach that the composition is use to polish metal, barrier layer and dielectric material such as silicon oxide (abstract and paragraph 0033).

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Therefore, it would have been obvious to form similar steric repulsion or steric hindrance between the substrate and the particles because the substrate comprises dielectric material such as silicon oxide as taught by Ma et al.

As to claims 4-8, Ma et al teach that the pH of the polishing composition is in the range of 2 to about 4.8 (paragraph 0050) and preferably in the pH range of 4-10 (paragraph 0069).

As to claims 9-10, Ma et al teach that the nominal particle size is in the range of about 3 to 100 nm (paragraphs 0047 and 0070-0071).

As to claims 13-18, Ma et al broadly teach the surfactants may be cationic or anionic (paragraph 0060 at page 5).

5. Claims 1,3-6, 8-18 and 35 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hartog et al (6,236,542) in view of Kramer et al (6,630,403).

As to claims 1,11-12 and 35, Hartog et al disclose a cleaning polish etch composition comprises a carrying fluid such acid, neutral or base solution and metal etchant such as aluminum nitrate or cerium sulfate or any other etchant depending on the substrate for etching the substrate and/or the attached slurry particles (col.4, lines 19-28, col.5, lines 60-col.6, lines 17).

Hartog et al fail to teach the composition comprises a surfactant that forms a steric hindrance barrier between the substrate and the colloidal particles.

However, Kramer et al disclose a polishing composition including silica abrasive and surfactant, wherein the surfactant forming particle barrier layer or flow modifiers to

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reduce roughening on the polished surface in order to reduce scratches and eventually cracking on the polished surface and the reduction of cracking decreases access of cleaning chemistry to underlying structures of the substrate (col.2, lines 1-5 and lines 53-67 and col.3, lines 13-21 and col.4, line 66-col.5, line 12 and col.6, lines 55-67).

Kramer et al do not explicitly teach that the surfactants form a steric hindrance barrier between the substrate and the colloidal particles but disclose that the surfactants are similar as the instant invention such cationic surfactants are derived from amine salt (col.5, lines 5-11) and expected to have similar effect.

Therefore, it would have been obvious to one of ordinary skilled in the art at the time of claimed invention to combine Kramer et al's teaching of introducing a surfactant into Hartog et al's composition for reducing scratches and cracks on the surface during polishing as taught by Kramer et al.

As to claim 3, Hartog et al teach that the substrate is a silicate based glass disk (col.4, lines 12-25).

As to claims 4-6, Hartog et al teach that the colloidal particles are silica based and pH of the composition could be about 1.0 (col.7, lines 8-13).

As to claim 8, Hartog et al teach that the pH of the composition could be above 3.0, which reads on claimed pH 3.5 (col.5, line s40-43).

As to claims 9-10, Hartog et al teach that the colloidal particles have a size in the range of 0.001-1 μ m (1-1000nm) (col.6, lines 25-29).

Hartog et al teach that the colloidal particles have a size in the range of 0.001-1 μ m (1-1000nm) (col.6, lines 25-29).

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6. Claims 7-8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hartog et al (6,236,542) in view of Kramer et al (6,630,403) and further in view of Small et al (6,251,150).

Modified Hartog et al discussed above in the paragraph 5 but fail to explicitly teach that the composition comprises colloidal alumina having a pH of about 3.5-10.5 (claim 8) or a pH of about 7-12 (claim 7).

However, Small et al (6,251,150) disclose a composition comprises colloidal particles of silica or alumina (aluminum oxide) having a pH of about 3.8-9.4 for maintaining the zeta potential of the slurry composition in order clean or remove the residue efficiently (col.10, lines 8-15, col.10, lines 48-51 and col.11, lines 4-7).

Therefore, it would have been obvious to one of ordinary skilled in the art at the time of claimed invention to combine Small et al's teaching into modified Hartog et al's composition for efficient removal of particles or residue as taught by Small et al.

7. Claim 40 is rejected under 35 U.S.C. 103(a) as being unpatentable over Ma et al (US 2003/0079416 A1) in view of Burton et al (6,083,838).

Ma et al discusses in the paragraph 4 above but fail to teach the claimed surfactant.

However, Burton et al disclose a CMP slurry composition containing abrasive and a surfactant is used to increase the polishing capability by increasing the viscosity of the slurry, wherein the surfactant is propylene oxide-ethylene oxide block copolymer (col.3, lines 62-65 and col.4, line 64-col.5, line 9).

Therefore, it would have been obvious to one of ordinary skilled in the art at the time of claimed invention to combine Burton et al's teaching into Ma et al's composition for increasing the polishing efficiency as taught by Burton et al.

8. Claims 41-42 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ma et al (US 2003/0079416 A1) in view of Roberts (5,723,181).

Ma et al discusses in the paragraph 4 above but fail to teach the specific surfactant of sodium octyl sulfate in the composition.

However, Roberts teaches that surfactant such as sodium octyl sulfate is used in a colloidal silica composition for changing the surface chemistry and resulted surface is more susceptible to the surface processing (col.1, lines 49-60 and col.2, lines 46-53).

Therefore, it would have been obvious to one of ordinary skilled in the art at the time of claimed invention to combine Roberts's teaching into Ma et al's composition for enhancing the polishing of the surface by changing the surface chemistry as taught by Roberts.

It is noted that it would have been obvious that the surfactant is precipitated onto the surface because the surfactant is exactly same as the instant invention and expected to have the similar result.

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Conclusion

9. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Edelstein et al (6,153,043) teach the introduction of surfactant such as sodium octyl sulfate in a CMP composition increasing the polishing rate by inhibiting the oxidation and reduction reaction (col.8, lines 17-32).

10. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Shamim Ahmed whose telephone number is (571) 272-1457. The examiner can normally be reached on M-Thu (7:00-5:30) Every Friday Off.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nadine G. Norton can be reached on (571) 272-1465. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Shamim Ahmed Primary Examiner Art Unit 1765

SA June 20, 2005